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ON Semiconductor®

## **FDMC7660**

# N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 20 A, 2.2 m $\Omega$

#### **Features**

- Max  $r_{DS(on)} = 2.2 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 20 \text{ A}$
- Max  $r_{DS(on)} = 3.3 \text{ m}\Omega$  at  $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 18 \text{ A}$
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

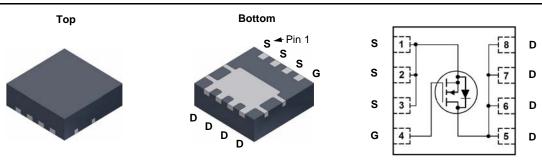


## **General Description**

This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

#### **Applications**

- DC DC Buck Converters
- Point of Load
- High Efficiency Load Switch and Low Side Switching



Power 33

#### **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
$V_{DS}$	Drain to Source Voltage			30	V
$V_{GS}$	Gate to Source Voltage		(Note 4)	±20	V
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25°C		40	
	-Continuous (Silicon limited)	T <sub>C</sub> = 25°C		100	^
ID	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	20	Α
	-Pulsed			200	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	200	mJ
$P_{D}$	Power Dissipation	$T_C = 25^{\circ}C$		41	W
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.3	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to + 150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	53	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7660	FDMC7660	Power 33	13"	12 mm	3000 units

# **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
$\frac{\Delta BV_{DS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to 25°C		14		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μА
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.2	1.7	2.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to 25°C		-6		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		1.8	2.2	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 18 A		2.6	3.3	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125^{\circ}\text{C}$		2.2	3.1	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V, } I_{D} = 20 \text{ A}$		163		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1MHz	3630	4830	pF
C <sub>oss</sub>	Output Capacitance		1345	1790	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		110	165	pF
$R_g$	Gate Resistance		0.9		Ω

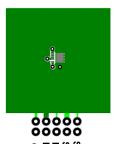
## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		14	25	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 20 A,	6.8	14	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	36	58	ns
t <sub>f</sub>	Fall Time		5.7	11	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	54	86	nC
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$	24	38	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 20 A	11		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		5.6		nC

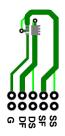
#### **Drain-Source Diode Characteristics**

V	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 20 \text{ A}$ (Note 2)	0.8	1.2	W
VSD	Source-Drain blode Forward voltage	$V_{GS} = 0 \text{ V, } I_S = 1.9 \text{ A} $ (Note 2)	0.7	1.2	] V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>E</sub> = 20 A, di/dt = 100 A/μs	45	63	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 20 A, α/αι = 100 A/μs	25	35	nC
Notoce					

<sup>1.</sup> R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design while R<sub>0JA</sub> is determined by the user's board design.



a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%. 3. Starting  $T_J = 25$  °C, L = 1 mH,  $I_{AS} = 20$  A,  $V_{DD} = 27$  V,  $V_{GS} = 10$  V 4. As an N-channel device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

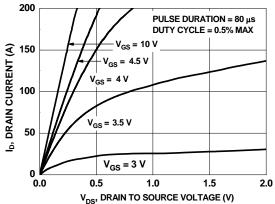
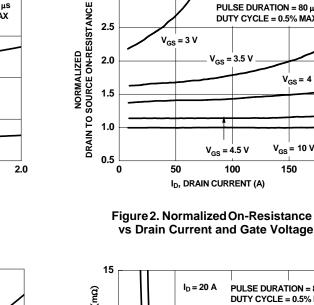


Figure 1. On Region Characteristics



3.0

2.5

2.0

 $V_{GS} = 3 V$ 

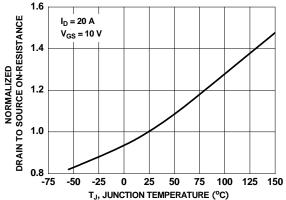
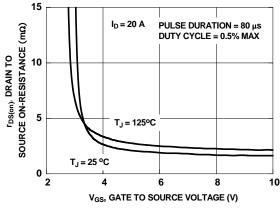


Figure 3. Normalized On Resistance vs Junction Temperature



PULSE DURATION = 80 μs

DUTY CYCLE = 0.5% MAX

 $V_{GS} = 4 V$ 

V<sub>GS</sub> = 10 V

200

150

 $V_{GS} = 3.5 \text{ V}$ 

Figure 4. On-Resistance vs Gate to Source Voltage

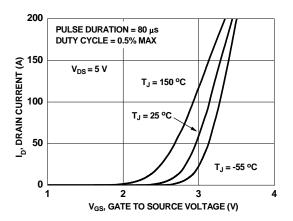


Figure 5. Transfer Characteristics

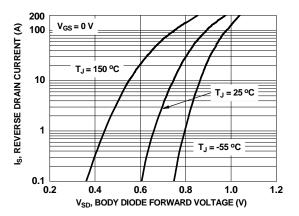


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

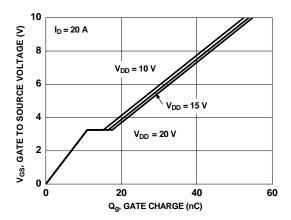


Figure 7. Gate Charge Characteristics

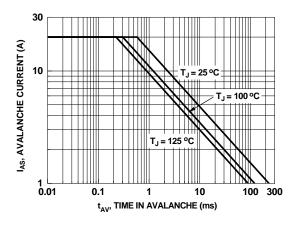


Figure 9. Unclamped Inductive Switching Capability

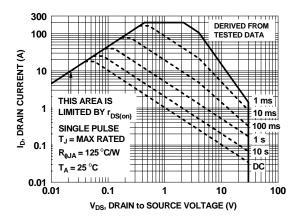


Figure 11. Forward Bias Safe Operating Area

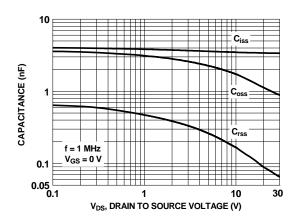


Figure 8. Capacitance vs Drain to Source Voltage

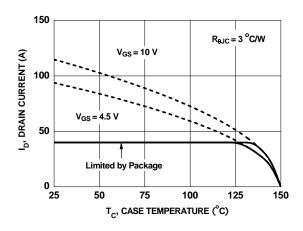


Figure 10. Maximum Continuous Drain Current vs Case Temperature

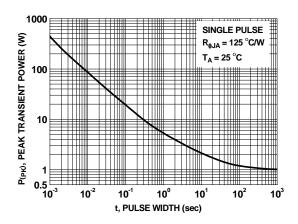


Figure 12. Single Pulse Maximum Power Dissipation

## Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

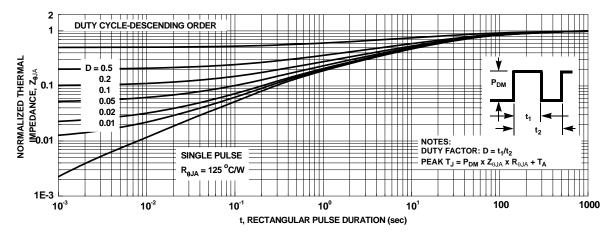
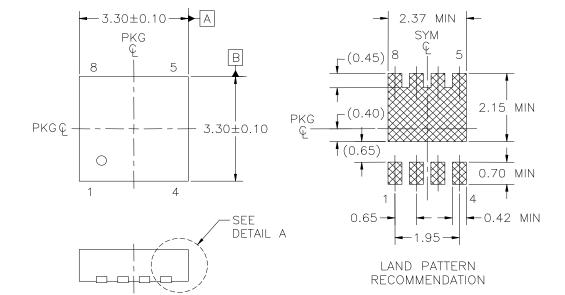
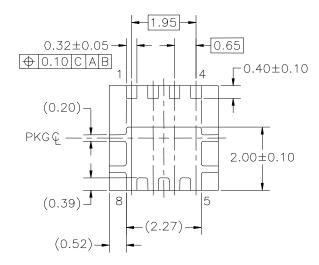
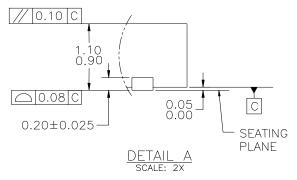


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

## **Dimensional Outline and Pad Layout**







PQFN08BREV1

NOTES: UNLESS OTHERWISE SPECIFIED

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